10-bit 33MSPS A/D Converter

Description

The CXA1844Q is a 10-bit 33MSPS 2-step parallel type A/D converter for video signal processing.

This A/D converter operates on ± 5V power supplies. The analog signal can be converted to the digital signal by using this IC in conjunction with the Sample-and-hold IC (CXA1843Q).

Features

Maximum operating speed

: 33MSPS (Min.)

Resolution

: 10-bit

Low power dissipation

: 320mW (Typ.)

Wide-band analog input

: 15MHz

Low input capacitance

: 50 pF (Typ.)

Built-in digital correction

(Compensation within ± 16 LSB)

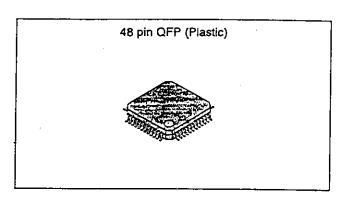
TTL input (Except CLK which is ECL LIKE)

TTL output

Output code

: binary/2S complement/

1S complement



Function

10-bit 33MSPS 2-step parallel type A/D converter

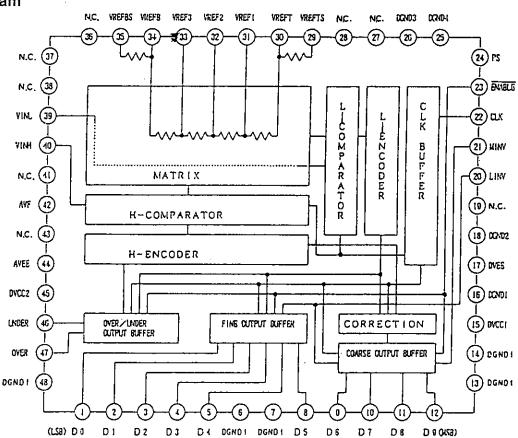
Structure

Bipolar silicon monolithic IC

Applications

High resolution video signal processing

Block Diagram



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			_		
Absolute Maximum Rat	lings (Ta=:	25℃)			
Supply voltage	DVcc1	•	0 to +6	8	V
	DVcc2		0 to +6	3 .	V
	AVEE		6 to €)	V
	DVEE		6 to 0)	V
Analog input voltage	VINH		AVEE to AV	F+0.3	V
	VINL		AVEE to AV	F+0.3	٧
Reference voltage	VREFT		AVEE to AVI	F+0.3	V
-	VREFB		AVEE to AV	F+0.3	٧
Digital input voltage	CLK		DGND1-0.5 to	DVcc1	V
	MINV		DGND1-0.5 to	DVcc1	٧
	LINV		DGND10.5 to	DVcc1	٧
	PS		DGND10.5 to		V
	ENABLE		DGND10.5 to	DVcc1	V
Digital output voltage	Vo		DGND1-0.51	o +3.6	V
	(Vo: The v	oltage is appli	ed to the output	pin for high impeda	ance outpi
Storage temperature	Tstg		-65 to 15		°C
Allowable power dissipation	Po		0.62		W
Recommended Operating	na Condit	tions			
	3	Min.	Тур.	Max.	Unit
Supply voltage	DVcc1	+4.75	+5	+5.25	V
- 1.7	DVcc2	+4.75	+5	+5.25	v
	DGND1	•	0	10.20	v
	DGND2		0		v
	DGND3	5	Ō		v
	DGND4		0		v
	AVF	+0.5	+0.7	+0.9	v
			. • • •		
	AVEE	-5.25	-5	-4.75	
	AVEE DVEE	5.25 5.25	-5 -5	-4.75 -4.75	V
 Analog input voltage 	DVEE	5.25	-5 -5	-4.75	V V
 Analog input voltage 	DVEE VINH	5.25 2		-4.75 0	V V V
• • •	DVEE VINH VINL	5.25 2 2	 5	-4.75 0 0	V V V
Analog input voltageReference voltage	DVEE VINH VINL VREFT	5.25 2 2 0.1	5 0	-4.75 0 0 +0.1	V V V
• • •	DVEE VINH VINL VREFT VREFB (CLK)	5.25 2 2	 5	-4.75 0 0	V V V
Reference voltage	DVEE VINH VINL VREFT VREFB	5.25 2 2 0.1	5 0	-4.75 0 0 +0.1	V V V
Reference voltage	DVEE VINH VINL VREFT VREFB (CLK)	-5.25 -2 -2 -0.1 -2.1	5 0 2	-4.75 0 0 +0.1	V V V V
Reference voltage	DVEE VINH VINL VREFT VREFB (CLK) VIH1 VIL1	-5.25 -2 -2 -0.1 -2.1	-5 0 -2 DVcc1-0.75 DVcc1-1.5	-4.75 0 0 +0.1 -1.9	V V V V
Reference voltage	DVEE VINH VINL VREFT VREFB (CLK) VIH1 VIL1	-5.25 -2 -2 -0.1 -2.1 DVcc1-0.9	-5 0 -2 DVcc1-0.75 DVcc1-1.5	-4.75 0 0 +0.1 -1.9	V V V V
Reference voltage	DVEE VINH VINL VREFT VREFB (CLK) VIH1 VIL1 (MINV, LIN	-5.25 -2 -2 -0.1 -2.1 DVcc1-0.9 V, PS, ENABL	-5 0 -2 DVcc1-0.75 DVcc1-1.5	-4.75 0 0 +0.1 -1.9	V V V V
Reference voltage	DVEE VINH VINL VREFT VREFB (CLK) VIH1 VIL1 (MINV, LIN VIH2	-5.25 -2 -2 -0.1 -2.1 DVcc1-0.9 V, PS, ENABL	-5 0 -2 DVcc1-0.75 DVcc1-1.5	-4.75 0 0 +0.1 -1.9 DVcc1-1.35	V V V V V
Reference voltageDigital input voltage	DVEE VINH VINL VREFT VREFB (CLK) VIH1 VIL1 (MINV, LIN VIH2 VIL2	-5.25 -2 -2 -0.1 -2.1 DVcc1-0.9 V, PS, ENABL +2	-5 0 -2 DVcc1-0.75 DVcc1-1.5	-4.75 0 0 +0.1 -1.9 DVcc1-1.35	<pre></pre>

Pin Description

1 111 20	escriptio	•			
Pin No.	Symbol	1/0	Pin voltage	Equivalent circuit	Description
1 to 5 8 to 12	D0 to D9	0		7 () 00-√304 → 304mz	Digital output D0 (LSB) to D9 (MSB)
46	UNDER	0	ΤΤL	@umoen @umoen	Underflow output
47	OVER	0		(a) 06 Mg 1	Overflow output
15	DVcc1		+5V		D:-3-1
45	DVcc2	—	Тур.		Digital power supply
6, 7 13, 14 16, 48	DGND1				
18	DGND2		GND		Digital ground
26	DGND3				
25	DGND4				
17	DVEE		-5V		Digital negative power supply
44	AVEE		Тур.		Analog negative power supply
20	LINV	i	TTL	₹	This input can invert output form of D0 to D8. In open condition, this pin turns to high level input. (For details, refer to the Output Formula Chart.)
21	MINV	ī	ΊΤL	ENABLE & SO	This input can invert output form of D9 (MSB). In open condition, this pin turns to high level input. (For details, refer to the Output Formula Chart.)
23	ENABLE	1	TTL	DVEE (I) (B) DGND1	3-state control. Turns to enable when low is input. In open condition, this pin turns to high level input.
24	PS	l	TTL		Power save input. Power save condition is entered when high level is input. In open condition, this pin turns to high level input.
22	CLK	1	ECL LIKE	DVec 1 DVec 1 1.2 OVER (1) OGNO 1	Clock input

Гъ:			 	1	
Pin No.	Symbol	1/0	Pin voltage	Equivalent circuit	Description
29	VREFTS		CAID		Reference voltage sense (Top)
30	VREFT	1	GND	VREFTS (2)	Reference voltage force (Top)
31	VREF1		-0.5V	VREF1 (5) 7 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	
32	VREF2		-1.0V	VREF3 (3)	
33	VREF3		-1.5V	VAEFBS S W	
34	VREFB	ı	_2V	AVEZ @	Reference voltage force (Bottom)
35	VREFBS		-2V	<u>-</u>	Reference voltage sense (Bottom)
39	VINL	1	–2V to 0V	VINL SAVEY	Analog input (Lower comparator input)
40	VINH	1	–2V to 0V	VINH @ #EF	Analog input (Upper comparator input)
42	AVF		+0.7V		Analog power supply
19, 27	N.C.				Open. Not connected to internal circuit, but connection to DGND (digital ground) is recommended.
28, 36 37, 38 41, 43	N.C.				Open. Not connected to internal circuit, but connection to AGND (analog ground) is recommended.

Electrical Characteristics

(Ta=25 °C , DVcc1, 2=+5V, DGND1 to 4=0V, AVF=0.7V, AVEE, DVEE=-5V, VREFB=-2V, VREFT=0V)

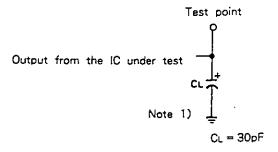
Item	Symbol	Ţ	Measure	ment Conditions	Min.	Тур.	Max.	Unit
Resolution	n				10	10	10	bit
DC characteristics	•	• • •	•				· · · · · · · · · · · · · · · · · · ·	
Integral linearity error	Ец				-1.5		+1.5	LSB
Differential linearity error	Ept	VIN	i=-2 to 0'	V	-1		+1	LSB
Analog input								
Analog input current	lін	VIN	=0		0	25	120	μА
Analog input capacitance	Cin	VIN	=-1V+0.	07Vrms		50		pF
Analog input band width	BW	-10	dB		15			MHz
Reference voltage input	•				····		_	
Reference current	REF	VRI	FB=-2V	·	16	-10	-7	mA
Reference resistance	RREF			· · · · · · · · · · · · · · · · · · ·	120	200	280	Ω
Offset voltage	Еот				5	10	25	mV
Onset voltage	Еов				5	10	25	mV
	VREF1					-0.5		
Reference voltage	VREF2					-1.0		V
	VREF3		3 *			-1.5		٧
Digital input								
	V _{tH1}	*1			DVcc1-0.9			V
Digital input voltage	VIL1		ĺ				DVcc1-1.35	V
Digital hiput voltage	ViH2	*2			2			V
	VIL2		į				0.8	V
	litt	*1		ViH=DVcc1-0.8V	– 10		+15	μА
Digital input current	liLi		DVcc1	ViL=DVcc1-1.6V	15		+10	μА
Signal input current	lıн2	*2	=Max.	ViH=2.7V	- 15		+15	μA
	1112	~ ~		VIL=0.5V	–25		0	μA
Digital input characteristics						2		рF

ltem	Symbol	Massurame	ent Conditions	B.din.	T	1	1
 	Symbol	Weasureme	ent Conditions	Min.	Тур.	Max.	Uni
Switching characteristics	T	,					
Maximum operating speed	Fc			33		ļ	MSPS
Clock pulse width	tрwн			14			ns
Olook palso waar	tpwl	*3	•	13			ns
Sampling delay	tsн			-2	1	2	ns
	tsı			-3	-2.5	1	ns
Output delay time	t DLH	*3 Ct=30pF		4		18	ns
Output delay lime	tonu	*5	4		18	ns	
3-state output disable time	tpHZ					150	ns
3-state output disable time	tplz	*4			100	ns	
3-state output enable time	tрzн	*6			300	ns	
3-state output enable time	tezu					150	ns
Digital output				· · · · · · · · · · · · · · · · · · ·			
Digital output voltage	Voн	Іон=-500 μ А	D) (14	2.7	3.4		٧
Digital output voltage	Vol	lot=1mA	DVccz=Min.			0.5	V
Leak current during output off	loz	DVccz=Max., Vo=3.6V (Max.)		-20		150	μА
Dynamic characteristics							
Differential gain error	DG	NTSC 40IRE mod ramp, Fc=14.3MSPS			0.5		%
Differential phase error	DP				0.3		deg
		Fc=33MSPS F	Fin=1kHz	1 1	57		_ ₫B
SNR	SNR	Fc=33MSPS	1MHz		53		dB
		Fc=33MSPS F	Fin=8MHz		50		dB

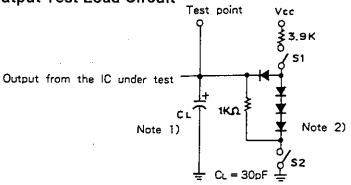
Item	Symbol	Measurement Conditions	Min.	Тур.	Max.	Unit
Power supply		<u> </u>				
DVcc1 current	I== .	DVcc1=5V	9	20	30	mA
Dvcci current	lovec ₁	*7 During power save	7.5	14.5	21.5	mA
DVcc2 current	laura	DVcc2=5V	0.001	0.3	1	mA
DVCC2 current	lovcc2	*7 During power save	0	0	0.1	mA
AVEE current + DVEE current	luss	AVEE=-5V, DVEE=-5V	-57.5	-38	-20.8	mA
Avee corrent + Dvee corrent	IVEE	*7 During power save	-4.4	-2.8	-1.6	mA
AVF current	lave	AVF=0.7V	3.5	6.8	10.5	mA
Avi cuiteit	IAVF	*7 During power save	30	55	85	μА
Power dissipation Pd=A+B+C A=(lbvcc1+lbvcc2+ lvEE) × 5V B=lavF × 0.7V	Pd		178	316	482	mW
C= IREF × 2V		*7 During power save	59	107	163	mW

- *1 CLK input
- *2 MINV, LINV, ENABLE, and PS inputs
- *3 Refer to Timing Diagram (1)
- *4 Refer to Timing Diagram (2)
- *5 The load is a bi-state totem-pole output delay time test load circuit.
- *6 The load is a 3-state output test load circuit.
- *7 When PS and ENABLE inputs are in high level.

Bi-state Totem-pole Output Delay Time Test Load Circuit



3-state Output Test Load Circuit

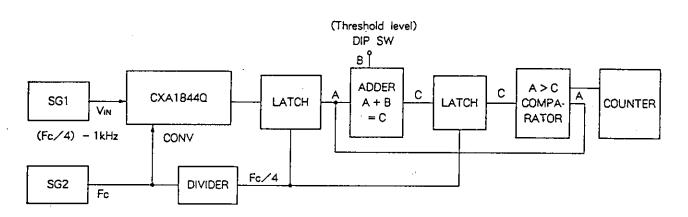


Test condition	S1	S2
tpzl_	Close	Open
tрzн	Open	Close
tpuz tpuz	Close	Close

Note 1) CL includes probe capacitance and parasitic capacitance in Test Board.

Note 2) All diodes are IS2076.

Error Rate Test Circuit



Notes on Operation

Analog ground (Analog ground on PCB)
 Keep analog ground surface on PCB as wide as possible with impedance and resistance as low as possible.

2. Digital ground (DGND1, DGND2, DGND3, DGND4)

Upon mounting to PCB keep ground surface as wide as possible with impedance and resistance as low as possible.

Moreover, a common analog and digital ground immediately near ADC will help obtain characteristics smoothly.

3. Digital positive power supply (DVcc1, DVcc2)

Connect to the digital ground with a ceramic capacitor over 0.1 µF and as close to the pins as possible. Insert a ceramic capacitor between DVcc2 and DGND1 of TTL output power supply as shortly as possible because noise tends to occur.

4. Analog positive power supply (AVF)

As shown in the Standard Circuit, make the positive power supply about +0.7V by connecting to the analog ground with a diode and +5V with a pull-up resister respectively.

Connect to the analog ground on PCB with a ceramic capacitor over 0.1 µF as close to the pin as possible.

5. Analog negative power supply (AVEE)

Connect to the analog ground on PCB with a ceramic capacitor over 0.1 µF as close to the pin as possible.

6. Digital negative power supply (DVEE)

Connect to the digital ground with a ceremic capacitor over 0.1 µF as close to the pin as possible.

When VEE is divided into digital and analog, there is continuity because of about 4Ω resistance between the two inside the IC. Accordingly, if an excessive potential difference (more than 100mV) is applied continuously, this may destroy the IC. To prevent the IC destruction, connect AVEE and DVEE with a inductance having good high frequency characteristics. Prevent noise mixing and the generation of potential difference between analog and digital.

7. Reference voltage (VREFTS, VREF1, VREF1, VREF2, VREF3, VREFB, VREFBS)

These pins provide reference voltage to upper and lower comparators. Voltage between VREFT and VREFB corresponds to input dynamic range.

There is a 200Ω resistance between VREFT and VREFB. By applying 2V to both pins a current of about 10 mA flows. When the reference voltage is destabilized by the clock, ADC characteristics are adversely affected. Connect VREFT and VREFB to the analog ground on PCB by means of a tantalum capacitor over $10\,\mu\text{F}$ and a ceramic capacitor over $0.1\,\mu\text{F}$ respectively. Also, connect each of VREF1, VREF2 and VREF3 to the analog ground on PCB using a ceramic capacitor over $0.1\,\mu\text{F}$. This will provide stability to the characteristics of high frequency. Strictly speaking on reference voltage VREFT side and VREFB side there is a respective about 10mV offset.

When there is no problem with the usage of those offset voltages, voltage is applied directly to VREFT, VREFB. In case the reference voltage is to be strictly applied, adjust to obtain an offset voltage of 0V, keeping VREFTS and VREFBS as sense pins and VREFB as force pins to form a feedback loop circuit. For details, see the Standard Circuit.

8. Analog input (VINH, VINL)

VINH is the input pin for the upper comparator while VINL is the input pin for the lower comparator.

Keep the input signal level within the level between VREFT and VREFB.

As this IC's analog input capacitance stands at about 50pF, it is necessary to drive with an buffer amplifier having sufficient driving capability. Also, when driving is done with the buffer amplifier of a low output impedance, as A/D converter input capacitance is large, ringing is generated and settling time grows longer. Here a small resistance of about 5 to 30Ω is connected in series between the buffer amplifier and each of A/D converter's VINH and VINL, as a dumping resistance. This eliminates ringing and shortens settling time. Also keep wiring between buffer amplifier and A/D converter as short as possible.

Clock input (CLK)

ECL LIKE input. Adds the signal of Vcc1 (5V) –0.8V at high level and Vcc1 (5V) –1.6V at low level. Clock line wiring should be the shortest possible while distanced from other signal lines to avoid affecting them.

This IC is 2-step parallel type A/D converter. Accordingly an external sample-and-hold circuit (SH) is necessary. However the timing between this SH circuit output waveform (A/D converter analog input waveform) and the A/D converter clock timing requires attention. In the relation between A/D converter clock and the A/D converter analog input signal, with the timing TH of the rising edge of A/D converter clock, the upper comparator compares the input signal and the reference voltage to latch the results. After that, with the timing TL of the falling edge of A/D converter clock, the lower comparator compares the input signal and reference signal to latch the results. (Strictly speaking, the sampling delay tsh is in TH and the sampling delay tsl is in TL.)

In this A/D converter, the lower comparator features a length of ±32mV (±16 LSB) redundance in relation to the upper comparator. At the timing when the lower comparator compares input signal and reference signal to latch at the timing TL, it is necessary to have the SH output settling performed. But at the timing when the upper comparator compares input signal and reference voltage to latch at the timing TH, as long as the SH output is within the ±32mV range to the final settling value, digital correction applies, A/D conversion precisely occurs. As seen from the above, A/D converter clock rise and fall timing versus SH output waveform should be duly considered. For the clock high level time tpwH and low level time tpwL, set to a value in excess of the time indicated for the respective operating conditions.

Output data is synchronously with the clock rising edge.

For details on timing, refer to the Timing Chart.

10. MINV input (MINV)

Digital output polarity inversion control pin of D9 (MSB).

TTL input. At open, turns to high level input.

For correspondence with analog input voltage and output data code, refer to the Output Formula Chart.

11. LINV input (LINV)

Digital output polarity inversion control pin of D8 to D0 (LSB).

TTL input. At open, turns to high level input.

For correspondence with analog input voltage and output data code, refer to the Output Formula Chart.

12. Output enable (ENABLE)

3-state control pin of digital output (D0 to D9, UNDER, OVER)

TTL input. At open, turns to high level input. At that time digital output turns all to high impedance.

13. Power save input (PS)

Power save control pin of internal circuit.

TTL input. At open, turns to high level input.

To set to power save mode, turn both PS and ENABLE to high level input.

14. Digital output (D0 to D9)

Output pin of D9 (MSB) to D0 (LSB).

TTL output.

Output data polarity inversion is executed by means of MINV and LINV signals. Can output in binary, 1S complement and 2S complement.

Also, by turning ENABLE signal to high level, the output can be turned into high impedance output.

However, when the output level is for high impedance output or is in power save mode, the voltage of 3.6V or more must not be applied to prevent the distruction of IC.

For correspondence with analog input voltage and output data code, refer to the Output Formula Chart. For the timing, refer to the Timing Chart.

15. Overflow output (OVER)

When the input signal exceeds VREFT, overflow signal is output.

MINV and LINV have no effect on this pin.

Also by turning ENABLE signal to high level, the output can be turned into high impedance output.

However, when the output level is for high impedance output or is in power save mode, the voltage of 3.6V or more must not be applied to prevent the distruction of IC.

For correspondence with analog input voltage and output data code, refer to the Output Formula Chart.

For the timing, refer to the Timing Chart.

16. Underflow output (UNDER)

When the input signal turns below VREFB, underflow signal is output.

MINV and LINV have no effect on this pin.

Also by turning ENABLE signal to high level, the output can be turned into high impedance output.

However, when the output level is for high impedance output or is in power save mode, the voltage of 3.6V or more must not be applied to prevent the sistruction of IC.

For correspondence with analog input voltage and output data code, refer to the Output Formula Chart.

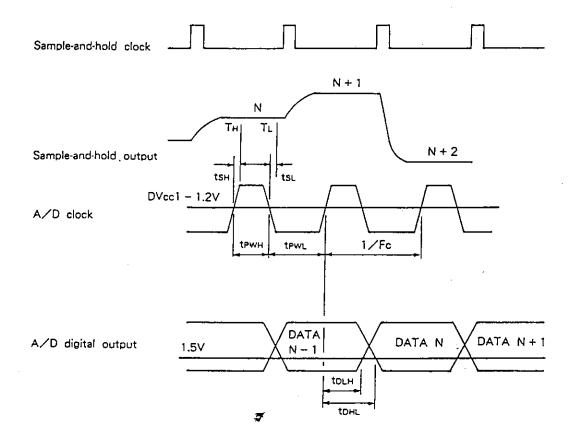
For the timing, refer to the Timing Chart.

Chart
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5
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utp
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		,——													
1 (OPEN)				7	7	Z	7		2		Z	7	z	Z	Z
0	0	0	0F9876543210UF (MSB) (LSB)	11111111110	011111111100	011111111010	01111111000		001111111110		000000001000	00000000110	0000000000000	00000000010	000000000000
0	0	1 (OPEN)	0F9876543210UF (MSB)	110000000000	0100000010	01000000100	01000000110		0000000000000	•••	001111110110	001111111000	001111111010	001111111100	001111111111
0	1 (OPEN)	0	0F9876543210UF (MSB) (LSB)	10111111110	00111111100	001111111010	001111111000		01111111110	•••	01000001000	01000000110	01000000100	01000000010	010000000001
0	1 (OPEN)	1 (OPEN)	0F9876543210UF (MSB) (LSB)	100000000000	00000000000	00000000100	00000000110	•••	010000000000	•••	0111111110110	011111111000	011111111010	01111111100	01111111111
3 <u>LE</u>	^!	>	TUc	0	-	2	ო		512	•••	1019	1020	1021	1022	1023
ENABLE	NIM	TINA	OUTPUT	8	•••										-2V

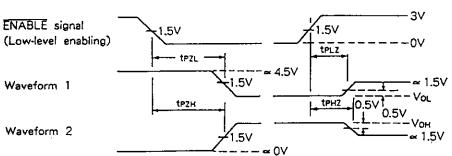
OF: OVER FLOW UF: UNDER FLOW 0: VOLTAGE LEVEL-LOW 1: VOLTAGE LEVEL-HIGH 2: HIGH IMPEDANCE

Timing Chart (1)



TH is the timing of latching result for the comparator of VIN and VREF in the upper comparators. TL is the timing of latching result for the comparator of VIN and VREF in the lower comparators.

Timing Chart (2)



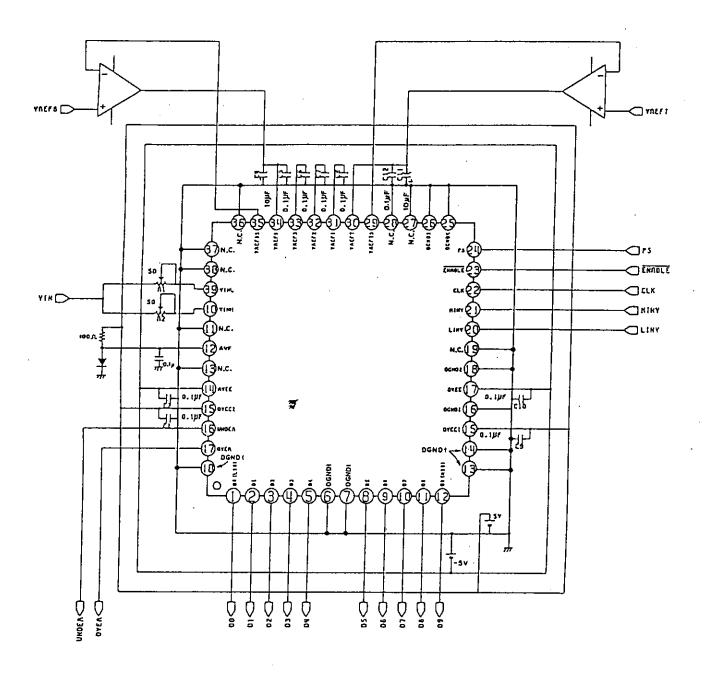
Output waveform of 3-state enable and disable time *. (* Enable time=tpzL/tpzH, disable time=tptz/tpHz)

Notes) Waveform 1 indicates the output waveform when internal conditions are set to obtain a low level output, with the exception of when output is disabled by means of the **ENABLE** signal.

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Waveform 2 indicates the output waveform when internal conditions are set to obtain a high level output, with the exception of when output is disabled by means of the ENABLE signal.

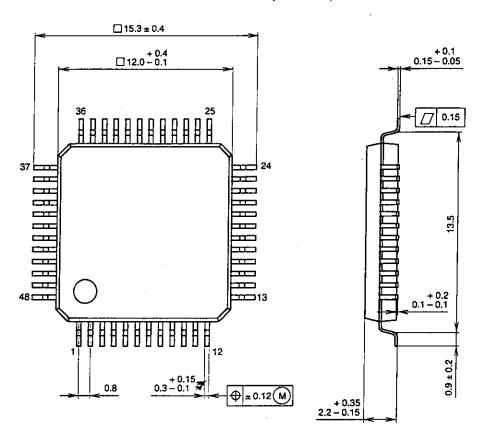
Standard Circuit



Package Outline

Unit: mm

48PIN QFP (PLASTIC)



PACKAGE STRUCTURE

SONY CODE	QFP-48P-L04
EIAJ CODE	-QFP048-P-1212-8
JEDEC CODE	

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER / PALLADIUM PLATING
LEAD MATERIAL	COPPER / 42 ALLOY
PACKAGE WEIGHT	0.7g

NOTE: PALLADIUM PLATING

This product uses S-PdPPF (Sony Spec.-Palladium Pre-Plated Lead Frame).